

ISSUE CLASSIFICATION	
Class	Subclass

PATENT NUMBER

**U.S. UTILITY Patent Application**

Q.I.P.E. <i>mk</i>	PATENT DATE
SCANNED <i>Q20</i> <i>aa</i> <i>mk</i>	

APPLICATION NO. 09/834014	CONT/PRIOR D	CLASS <del>438</del> 257	SUBCLASS 703	ART UNIT <del>2812</del> 2826	EXAMINER A. DUTAR
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APPLICANTS Scott Jacobs

TITLE Microelectronic packages including thin film metal and dielectric adhesive layer having conductive vias therein

PTO-2040  
12/89

[illegible]

<input type="checkbox"/> <b>TERMINAL DISCLAIMER</b>	<b>DRAWINGS</b> Sheets Drwg.      Figs. Drwg.      Print Fig.		<b>CLAIMS ALLOWED</b> Total Claims      Print Claim for C.G.	
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.	_____ (Assistant Examiner)      (Date)		<b>NOTICE OF ALLOWANCE MAILED</b>  	
<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S. Patent No. _____  _____  _____	_____ (Primary Examiner)      (Date)		<b>ISSUE FEE</b> Amount Due      Date Paid	
<input type="checkbox"/> The term of _____ months of this patent have been disclaimed.	_____ (Legal Instruments Examiner)      (Date)		<b>ISSUE BATCH NUMBER</b>	
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